



Silicon Carbide Schottky Diode

Features

- Positive temperature coefficient
- Temperature-independent switching
- Maximum working temperature at 175 °C
- Unipolar devices and zero reverse recovery current
- Zero forward recovery voltage
- Essentially no switching losses
- Reduction of heat sink requirements
- High-frequency operation
- Reduction of EMI

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical

	SYMBOL	UNIT	VALUE
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YJD106506FQG2

Electrical Characteristics

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	Typ.	Max.
Forward voltage drop	V_F	V	$I_F=6A, T_J=25^{\circ}C$	1.31	1.5
			$I_F=6A, T_J=175^{\circ}C$	1.65	-
Reverse leakage current	I_R	μA	$V_R=650V, T_J=25^{\circ}C$	0.5	25
			$V_R=650V, T_J=175^{\circ}C$	5	-
Total capacitive charge	Q_C	nC	$V_R=400V, T_J=25^{\circ}C, Q_C=\int_0^{V_R} C(V)dV$	25	-
Total capacitance	C	μF	$V_R=0V, f=1MHz$	378	-
			$V_R=200V, f=1MHz$	51	-
			$V_R=400V, f=1MHz$	49	-
Capacitance Stored Energy	E_C	μJ	$V_R=400V$	3	-

Thermal Characteristics ($T_a=25$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Value
Thermal resistance	R_{J-C}	$^{\circ}C/W$	4.76

Typical Characteristics

Figure 1. Forward CharacterCharacteristi

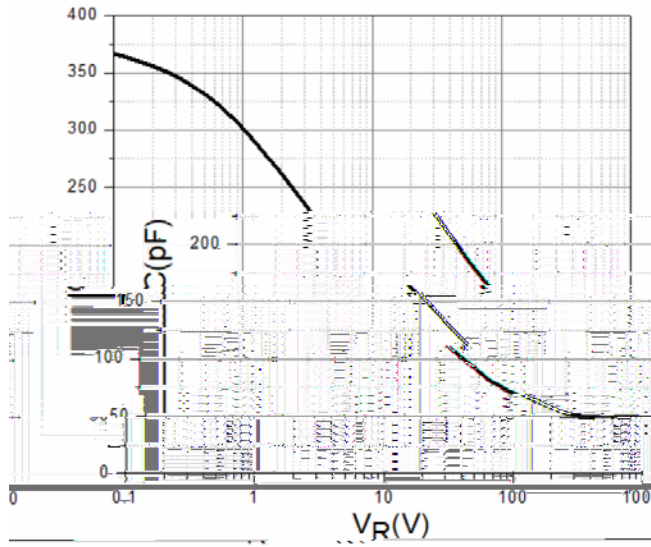


Figure 3. Capacitance vs. Reverse Voltage



Figure 4. Total Capacitance Charge vs. Reverse Voltage

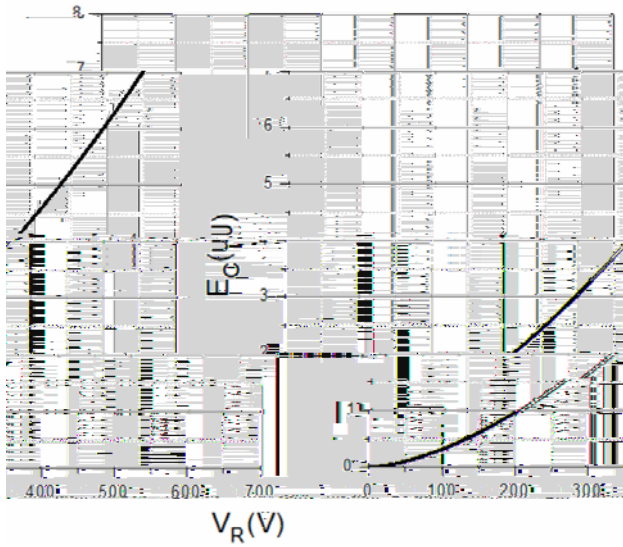


Figure 5. Capacitance Stored Energy

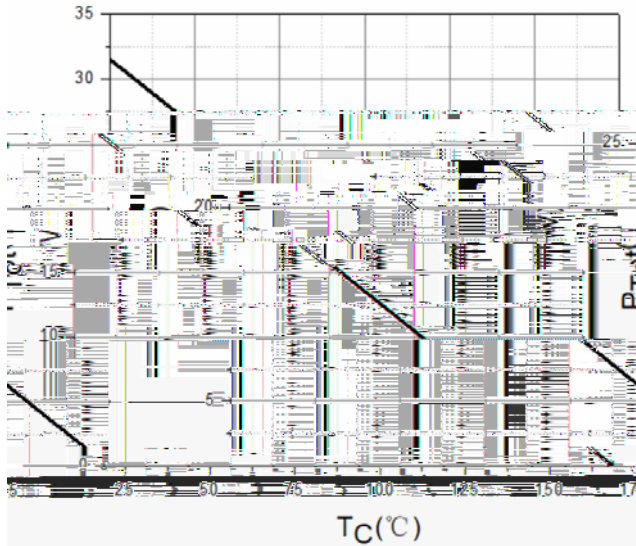


Figure 6. Power Derating

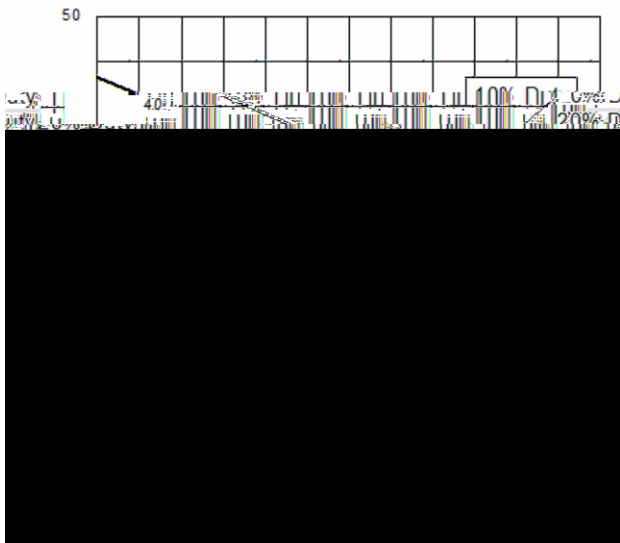


Figure 7. Current Derating

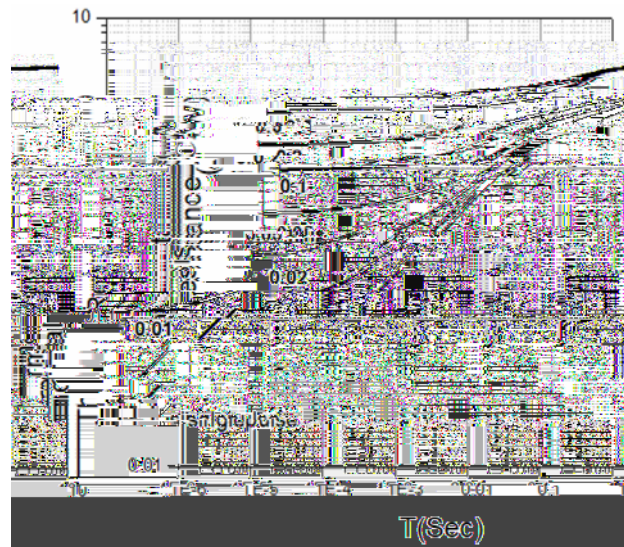
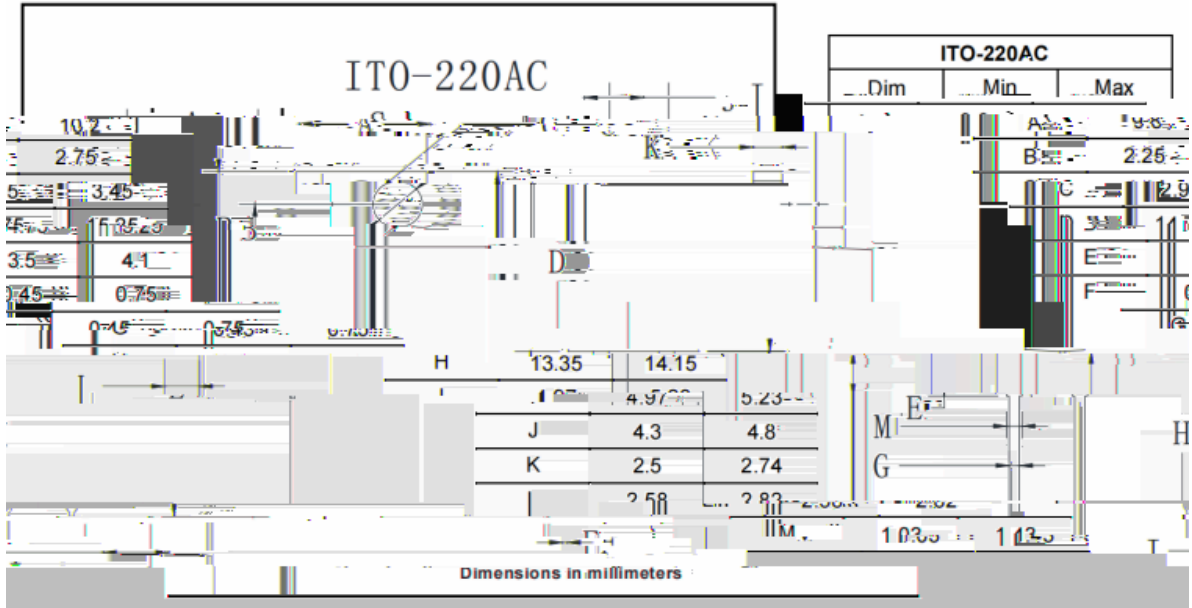


Figure 8. Transient Thermal Impedance



YJD106506FQG2

Outline Dimensions



'LVFODLPHU

7KH LQIRUPDQWRIC \$ QHWKLV GRFXPHQW<DQJRKUR XHIDQJHQZHHF(ROHFOVRUR Q&RF /VHG UHV
ULJKW WR PDNH FKDQJHRU ZW WIK R/XSMIKHRSVLRG XRF Q' R IGWV SFCDAIRYGHKUHUCILDEWQGMV L J XQ F
RU RWKHUZLVH

7KH SURGXFW OLVVJCH G HWRI EQH LXV B G VZH FWKURRQG IEQHTUX L S PHQW RU GHYLFHWWKDQG Q
HTXLSPHQW RU GHYLLFHH K IZJKL FKH VHHOGRW K H PLDDEIXOLFWML B Q X B G QGLEDJGHFWOK XPFKQDQVLIH
PHGLFDO LQVWUXPHQW VIT XLLSDFWSSRUFHMDUFAK LQX FOH DU UHDFVXHUO FFROQWUURROOHUW D Q
GHYLFHV <DQJMLHW R LE HDIDRQ HDR/Q XLP H O LQRI B HV S IRDE/LQEL W/H V R O VDIQQ JGIDJRPJMMFK LP
RI VDOH

7KLV SXEOLFDWLRG SVXSSHHW HDGIVLQURQJPDVXLSRQL HSGHYRUR XDGGLRQL FSOCHD V B WRHJPLW R X
KWVZZ \DQJMLH FRP